

AAP Gen 7 (TO-240AA) Power Modules Schottky Rectifier, 400 A



PRIMARY CHARACTERISTICS			
I _{F(AV)}	400 A		
V_{R}	150 V		
Package	AAP Gen 7 (TO-240AA)		
Circuit configuration	Two diodes common cathode		

MECHANICAL DESCRIPTION

The AAP Gen 7, new generation of ADD-A-PAK module, combines the excellent thermal performances obtained by the usage of exposed direct bonded copper substrate, with advanced compact simple package solution and simplified internal structure with minimized number of interfaces.

FEATURES

- 175 °C T_J operation
- · Low forward voltage drop
- High frequency operation
- · Low thermal resistance
- UL approved file E78996



- · Designed and qualified for industrial level
- · Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

BENEFITS

- · Excellent thermal performances obtained by the usage of exposed direct bonded copper substrate
- High surge capability
- · Easy mounting on heatsink

ELECTRICAL DESCRIPTION / APPLICATIONS

The VS-VSKCS409/150 Schottky rectifier common cathode has been optimized for low reverse leakage at high temperature. The proprietary barrier technology allows for reliable operation up to 175 °C junction temperature. Typical applications are in high current switching power supplies, plating power supplies, UPS systems, converters, freewheeling diodes, welding, and reverse battery protection.

MAJOR RATINGS AND CHARACTERISTICS							
SYMBOL	CHARACTERISTICS	VALUES	UNITS				
I _{F(AV)}	Rectangular waveform	400	Α				
V _{RRM}		150	V				
I _{FSM}	t _p = 5 μs sine	20 000	Α				
V _F	200 A _{pk} , T _J = 125 °C	0.85	V				
TJ	Range	-55 to +175	°C				

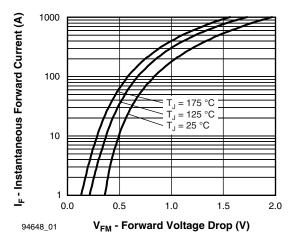
VOLTAGE RATINGS					
PARAMETER	SYMBOL	VS-VSKCS409/150	UNITS		
Maximum DC reverse voltage	V_{R}	150	V		
Maximum working peak reverse voltage	V_{RWM}	130	V		

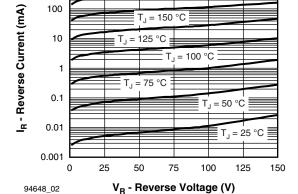


ABSOLUTE MAXIMUM RATINGS						
PARAMETER		SYMBOL	TEST CONDITIONS		VALUES	UNITS
Maximum average	per module		50 % duty cycle at T _C = 105 °C, rectangular waveform		400	
forward current	per leg	I _{F(AV)}			200	
Maximum peak one cycle	Maximum peak one cycle	I _{FSM} -	5 μs sine or 3 μs rect. pulse	Following any rated load condition and with rated V _{RRM} applied	20 000	Α
non-repetitive surge current			10 ms sine or 6 ms rect. pulse		2300	
Non-repetitive avalanche energ	y	E _{AS}	T _J = 25 °C, I _{AS} = 1.8 A, L = 10 mH		15	mJ
Repetitive avalanche current		I _{AR}	Current decaying linearly to zero in 1 μ s Frequency limited by T _J maximum V _A = 1.5 x V _R typical		Α	

ELECTRICAL SPECIFICATIONS					
PARAMETER	SYMBOL	TEST CONDITIONS		VALUES	UNITS
		200 A	T _J = 25 °C	1.03	V
Maximum forward voltage drop		400 A		1.33	
Maximum forward voltage drop	V_{FM}	200 A	T _J = 125 °C	0.85	
		400 A		1.13	
Maximum reverse leakage current	A	T _J = 25 °C	V _R = Rated V _R	6	mA
Maximum reverse leakage current	I _{RM}	T _J = 125 °C		85	IIIA
Maximum junction capacitance	C _T	$V_R = 5 V_{DC}$ (test signal range 100 kHz to 1 MHz), 25 °C		6000	pF
Typical series inductance	L _S	Measured lead to lead 5 mm from package body		5.0	nH
Maximum voltage rate of change	dV/dt	Rated V _R		10 000	V/µs
Maximum RMS insulation voltage	V _{INS}	1 50 Hz		3000 (1 min) 3600 (1 s)	V

THERMAL - MECHANICAL SPECIFICATIONS					
PARAMETER		SYMBOL	TEST CONDITIONS	VALUES	UNITS
Maximum junction and storage temperature range		T _J , T _{Stg}		-55 to +175	°C
Maximum thermal resistance, junction to case per leg		R _{thJC}	DC operation	0.32	°C/W
Typical thermal resistance, case to heatsink per module		R _{thCS}		0.1	C/VV
Approximate weight				75	g
Approximate weight				2.7	oz.
Mounting torque ± 10 %	to heatsink		A mounting compound is recommended and the torque should be rechecked after a period of 3 h to allow for the	4	Nm
	busbar		spread of the compound.	3	INIII
Case style	•		JEDEC®	TO-240AA co	ompatible





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T_{.1} = 175 °C

Fig. 1 - Maximum Forward Voltage Drop Characteristics (Per Leg)

Fig. 2 - Typical Values of Reverse Current vs. Reverse Voltage

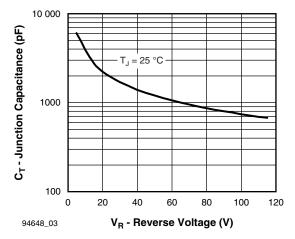


Fig. 3 - Typical Junction Capacitance vs. Reverse Voltage

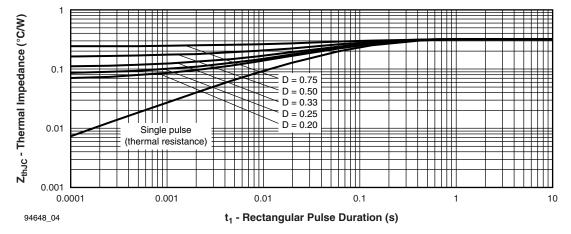


Fig. 4 - Maximum Thermal Impedance Z_{thJC} Characteristics (Per Diode)

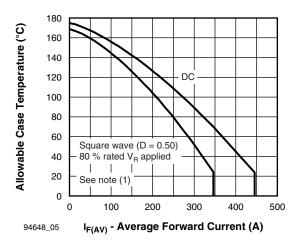


Fig. 5 - Maximum Allowable Case Temperature vs. Average Forward Current (Per Leg)

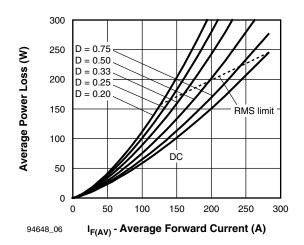


Fig. 6 - Forward Power Loss Characteristics (Per Leg)

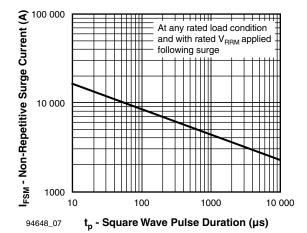


Fig. 7 - Maximum Non-Repetitive Surge Current

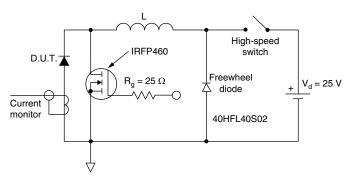
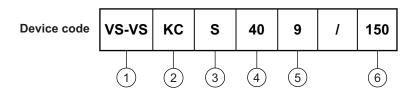


Fig. 8 - Unclamped Inductive Test Circuit

Note

 $^{(1)}$ Formula used: T_C = T_J - (Pd + Pd_{REV}) x R_{th,JC}; Pd = forward power loss = I_{F(AV)} x V_{FM} at (I_{F(AV)}/D) (see fig. 6); Pd_{REV} = inverse power loss = V_{R1} x I_R (1 - D); I_R at V_{R1} = 80 % rated V_R

ORDERING INFORMATION TABLE



1 - VS-VS = Vishay Semiconductors product

2 - Circuit configuration:

KC = ADD-A-PAK - 2 diodes common cathode

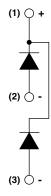
S = Schottky diode

Average current rating (40 = 400 A)

5 - Product silicon identification

6 - Voltage rating (150 = 150 V)

CIRCUIT CONFIGURATION



Γ	LINKS TO RELATED DOCUMENTS			
	Dimensions	www.vishay.com/doc?95369		



ADD-A-PAK Generation VII - Diode

DIMENSIONS in millimeters (inches)





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